



In re Reissue Application of:

Dennison et al.

U.S. Patent No.: 5,229,326

Issued: July 20, 1993

For: METHOD FOR MAKING ELECTRICAL CONTACT WITH AN ACTIVE AREA THROUGH SUB-MICRON CONTACT OPENINGS AND A SEMICONDUCTOR DEVICE

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<u>AMENDMENT</u>

Commissioner for Patents Washington, D.C. 20231

Sir:

The following amendments and remarks are filed in response to the Examiner's remarks in the Office Action mailed January 2, 2002, the three-month shortened statutory period for response to which expires on April 2, 2002.